

AMENDMENTS TO THE SPECIFICATION:

Please replace the first full paragraph beginning on page 5, line 2 with the following rewritten version:

When the manufacturing method for manufacturing non-contact ID card and the like is employed, it is sufficient that interposer boards are continuously taken from an electronic circuit board intermediate member, on which good interposer member are mounted, and that the interposer board is depressed on an antenna circuit board tape. Therefore, high-speed processing with high speed can be realized, and a large amount of non-contact ID cards can be manufactured within a short time period.

Please replace the third full paragraph beginning on page 5, line 20 with the following rewritten version:

When the manufacturing apparatus for manufacturing non-contact ID card and the like is employed, it is sufficient that interposer boards are continuously taken from an electronic circuit board intermediate member, on which good interposer member are mounted, and that the interposer board is depressed on an antenna circuit board tape.

Therefore, high speed processing with high speed can be realized, and a large amount of non-contact ID cards can be manufactured within a short time period.

Please replace the first full paragraph beginning on page 10, line 1 with the following rewritten version:

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As is understood from the foregoing, only good interposer boards 1 are disposed on the carrier tape 2 at every predetermined interval. Therefore, checking whether the interposer board or interposer boards 1 is or are good or failure defective, and a process, such as acceleration and deceleration in tape transfer, stopping operation, discharging of a failure defective interposer board, or discharging [[of]] a blank section, when a failure defective interposer board or boards is or are detected, [[are]] is unnecessary. As a result, arrangement for carrying out above series of process can be simplified, and overall required time can be shortened.